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PATENT

Docket No. JCLA6968

Date: 4-19-2001

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ASSISTANT COMMISSIONER FOR PATENTS  
WASHINGTON, D.C. 20231  
ATTENTION: APPLICATION BRANCH

Sir:

Transmitted herewith for filing is the patent application of

Inventors: Jian-Cheng Chen, Wei-Min Hsiao

For: PACKAGE OF A CHIP WITH BEVELED EDGES

Enclosed are:

- ☒ Specification 11 pages.
- ☒ 2 Sheets of drawings
- ☒ Recordation Form Cover sheet with 2 pages assignment.
- ☐ A certified copy of Taiwan Patent Application No.      dated     .
- ☒ **SIGNED** declaration and power of attorney.
- ☒ Return Prepaid postcard.

CLAIMS AS FILED

FOR	NUMBER FILED	NUMBER EXTRA	RATE	FEE
Basic Fee			\$710.00	\$710.00
Total Claims	18 — 20 = 0 ×		\$18.00	\$0.00
Independent Claims	4 — 3 = 1 ×		\$80.00	\$80.00
If application contains any multiple dependent claim (s), then add			\$270.00	\$0.00
TOTAL FILING FEE				\$790.00

- ☒ A check in the amount of \$790 cover the filing fee is enclosed.
- ☒ A check in the amount of \$40.00 to cover the assignment recording fee.
- ☒ A duplicate copy of this sheet is enclosed.

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Washington, D.C. 20231

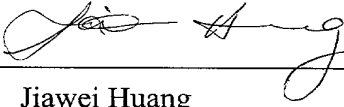
**CERTIFICATE OF MAILING BY "EXPRESS MAIL"**

**Docket No.** : JCLA6968  
**Applicant(s)** : Jian-Cheng Chen, Wei-Min Hsiao  
**For** : PACKAGE OF A CHIP WITH BEVELED EDGES  
**"Express Mail"** : EL608224368US  
**Mailing Label No.**  
**Date of Deposit** : April 19, 2001

I hereby certify that the accompanying

Transmittal in Duplicate; Specification 11 pages, 2 sheets of drawings; **SIGNED** Declaration and Power of Attorney 2 pages; Recordation Form Cover Sheet and Assignment 3 pages; Checks for Filing Fee(s); Return Prepaid Postcard

are being deposited with the United States Postal Service "Express Mail Post Office to Addressee" service under 37 CFR 1.10 on the date indicated above and are addressed to the Assistant Commissioner for Patents, Washington, D.C. 20231.

  
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Jiawei Huang